



Product Group: Vishay Passives/CC and NLR/Jan, 30th, 2019/PCN-NLR-001-2019 Rev 0

Change of Packaging Tape for Wirebondable NTC

DESCRIPTION OF CHANGE: Vishay has the intention to change the packaging tape of wirebondable NTC products. The new blistertape will be without punched hole in the cavity.

CLASSIFICATION OF CHANGE: Change of packaging.

REASON FOR CHANGE: Better protection against possible long term open air exposure of the taped parts

EXPECTED INFLUENCE ON QUALITY/RELIABILITY/PERFORMANCE: Positive for solderability of the electrode (especially after long term air exposure).

PRODUCT CATEGORY: Resistors, Non-Linear, Thermistors

PART NUMBERS/SERIES/FAMILIES AFFECTED: NTCC200*

NTCC300*

VISHAY BRAND(s): Vishay BC Components

TIME SCHEDULE: Start Shipment Date : August 1st 2019 (parts with new tape) Last Time Buy Date: NA Last Time Shipment Date: September 30th 2019 (parts with old tape) Although it is very improbable, between Aug. 1st and Sept. 30th mix shipments may still happen.

SAMPLE AVAILABILITY: Available upon request

PRODUCT IDENTIFICATION: Visual : Blister tape without hole and By date code

QUALIFICATION DATA: Available upon request

This PCN is considered approved, without further notification, unless we receive specific customer concerns before March 30th, 2019 or as specified by contract.

ISSUED BY: Tilly Laurent, Quality Eng, tilly.laurent@vishay.com

For further information, please contact your regional Vishay office.

CONTACT INFORMATION:

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